

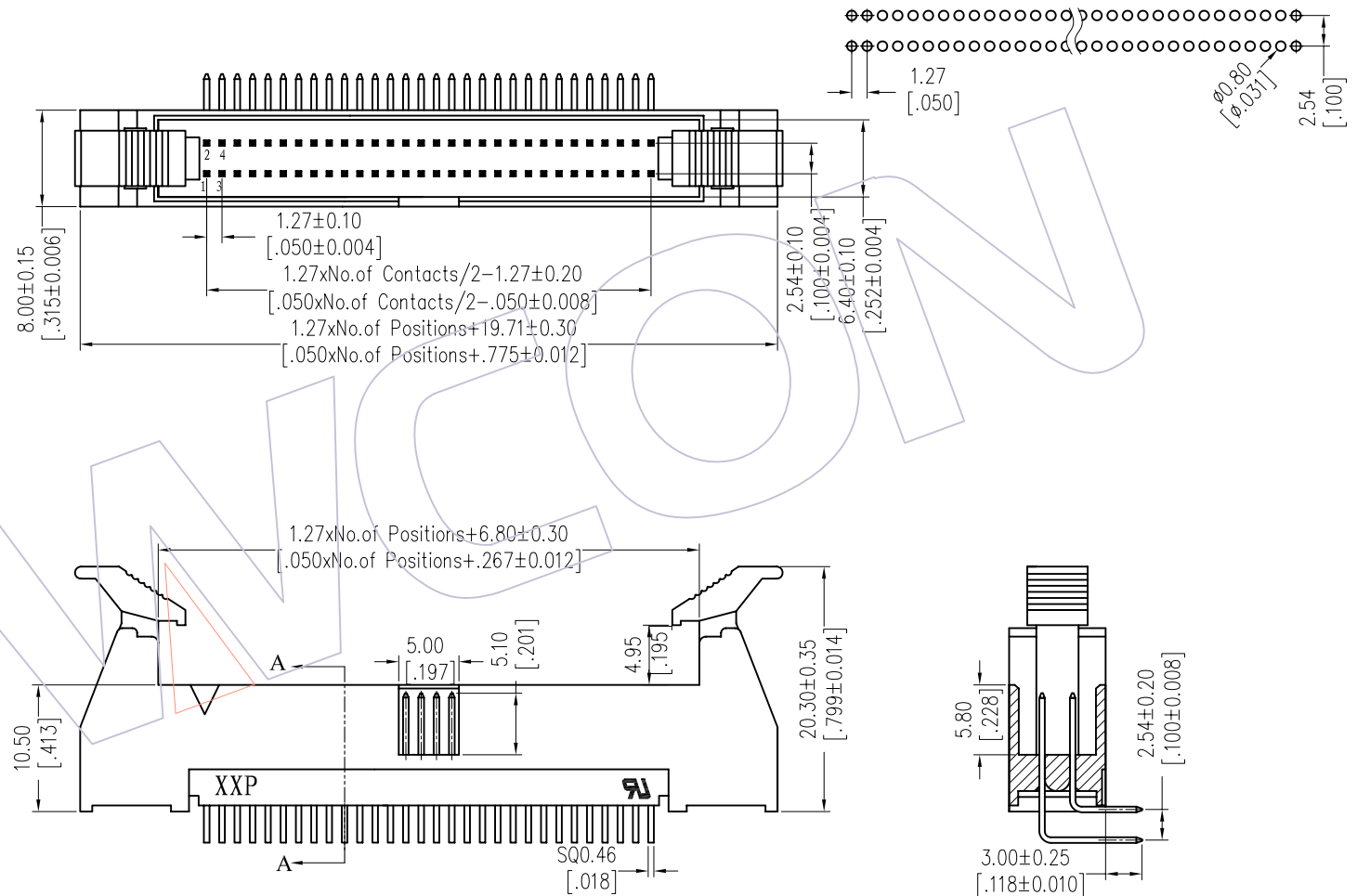
HSF

NOTES:

Current Rating: 1.0AMP
 Contact Resistance: 20mΩ Max
 Withstand Voltage: 500V AC/DC
 Insulation Resistance: 1000MΩ Min
 Operation Temperature: -40°C to +105°C

Contact Material: Brass
 Contact plating: Au Or Sn over Ni
 Insulator Material: PA9T+30%G.F UL94V-0

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



Ordering Information

3240-XX R XX B S X 1

No. of Pins	Contact Plating	Color Insulator	Packing
10 34	G0=Gold Flash	B=Black	T=Tube
12 40	G3=10u"Gold	U=Blue	
14 44	G4=15u"Gold	W=White	
16 50	G5=30u"Gold		
20 60	S0=Gold Flash/Tin		
24 64	S3=10u"Gold/Tin		
26 80	S4=15u"Gold/Tin		
30 100	S5=30u"Gold/Tin		
32	SN=Tin		

Item	Pitch	Mating
Standard	1.27X2.54	5242
Alternate		

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.	TITLE	CUSTOMER NO.
				X.X ±0.40	JYHuang	2012/10/05	UNIT	mm	3240-XXRXXBSX1		
				X.XX ±0.25	CHECK	DATE	SIZE	A4		1.27*2.54 EJECTOR HEADER 90° DIP	
				X.XXX ±0.15	APPROVE	DATE	SHEET	1/1			
				Angle ± 3'			PROJ.				
				DIM TOL							

WV